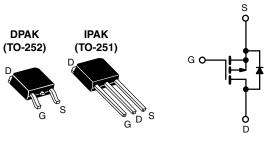


Vishay Siliconix

COMPLIANT

HALOGEN FREE

Power MOSFET



P-Channel MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	-60			
R _{DS(on)} (Ω)	$V_{GS} = -10 \text{ V}$	0.50		
Q _g max. (nC)	12			
Q _{gs} (nC)	3.8			
Q _{gd} (nC)	5.1			
Configuration	Sin	gle		

FEATURES

- · Dynamic dV/dt rating
- · Repetitive avalanche rated
- Surface mount (IRFR9014, SiHFR9014)
- Straight lead (IRFU9014, SiHFU9014)
- Available in tape and reel
- P-channel
- · Fast switching
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The DPAK is designed for surface mounting using vapor phase, infrared, or wave soldering techniques. The straight lead version (IRFU, SiHFU series) is for through-hole mounting applications. Power dissipation levels up to 1.5 W are possible in typical surface-mount applications.

ORDERING INFORMATION					
Package	DPAK (TO-252)	DPAK (TO-252)	DPAK (TO-252)	IPAK (TO-251)	
Lood (Dh) froe and balagon froe	SiHFR9014-GE3	SiHFR9014TRL-GE3 a	SiHFR9014TR-GE3 a	SiHFU9014-GE3	
Lead (Pb)-free and halogen-free	IRFR9014PbF-BE3	IRFR9014TRLPbF-BE3	IRFR9014TRPbF-BE3	-	
Lead (Pb)-free	IRFR9014PbF	IRFR9014TRLPbF ^a	IRFR9014TRPbF ^a	IRFU9014PbF	

Note

a. See device orientation

PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V _{DS}	-60	V
Gate-source voltage			V_{GS}	± 20	V
Continuous drain current	V _{GS} at 5 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$	l-	-5.1	
v_{GS} at 5 v_{GS} at 5 v_{GS} at 5 v_{GS}			I _D	-3.2	Α
Pulsed drain current ^a			I _{DM}	-20	
Linear derating factor				0.20	W/°C
Linear derating factor (PCB mount) e				0.020	W/ C
Single pulse avalanche energy b			E _{AS}	140	mJ
Repetitive avalanche current a			I _{AR}	-5.1	Α
Repetitive avalanche energy ^a			E _{AR}	2.5	mJ
Maximum power dissipation	$T_C = 2$	25 °C	_	25	w
Maximum power dissipation (PCB mount) e T _A = 25 °C			P_{D}	2.5	VV
Peak diode recovery dV/dt ^c			dV/dt	-4.5	V/ns
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C
Soldering recommendations (peak temperature) d	For ⁻	10 s		260	7

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b. $V_{DD} = -25 \text{ V}$, starting $T_J = 25 \,^{\circ}\text{C}$, $L = 6.3 \,\text{mH}$, $R_q = 25 \,\Omega$, $I_{AS} = -5.1 \,\text{A}$ (see fig. 12)
- c. $I_{SD} \le$ 6.7 A, $dI/dt \le$ 90 A/ μ s, $V_{DD} \le V_{DS}$, $T_{J} \le$ 150 °C
- d. 1.6 mm from case
- e. When mounted on 1" square PCB (FR-4 or G-10 material)

S21-0771-Rev. F, 19-Jul-2021 **1** Document Number: 91277



IRFR9014, IRFU9014, SiHFR9014, SiHFU9014

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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R _{thJA}	-	-	110	
Maximum junction-to-ambient (PCB mount) ^a	R _{thJA}	-	-	50	°C/W
Maximum junction-to-case (drain)	R _{thJC}	-	-	5.0	

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material)

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static							,
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D =$	= - 250 μA	-60	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference to	25 °C, I _D = -1 mA	-	-0.059	-	V/°C
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D}$	= -250 μA	-2.0	-	-4.0	V
Gate-source leakage	I _{GSS}	$V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA
Zero gate voltage drain current	I _{DSS}	V _{DS} = -60 V, \		-	-	-100	μA
During a second delication of the second			' _{GS} = 0 V, T _J = 125 °C	-	-	-500	0
Drain-source on-state resistance	R _{DS(on)}		I _D = -3.1 A b	-	-	0.50	Ω
Forward transconductance	9fs	$V_{DS} = -25 \text{ V}, I_{I}$	_D = -3.1 A ^D	1.4	-	-	S
Dynamic					ı		
Input capacitance	C_{iss}	$V_{GS} = 0 V$,		-	270	-	
Output capacitance	Coss	$V_{DS} = -25 \text{ V},$	$V_{DS} = -25 \text{ V},$		170	-	pF
Reverse transfer capacitance	C_{rss}	f = 1.0 MHz, see fig. 5		ı	31	ı	
Total gate charge	Qg			ı	-	12	
Gate-source charge	Q_gs	$V_{GS} = -10 \text{ V}$ $I_D = -6.7 \text{ A}, V_{DS} = -48 \text{ V},$ see fig. 6 and 13 b		1	-	3.8	nC
Gate-drain charge	Q_{gd}			-	-	5.1	
Turn-on delay time	t _{d(on)}			-	11	-	
Rise time	t _r	$V_{DD} = -30 \text{ V, I}$	$V_{DD} = -30 \text{ V}, I_{D} = -6.7 \text{ A},$		63	-	
Turn-off delay time	t _{d(off)}	$R_g = 24 \Omega$, $R_D = 4.0 \Omega$, see fig. 10 b		-	9.6	-	ns
Fall time	t _f	1	1		31	-	
Internal drain inductance	L _D	Between lead	D	-	4.5	-	
Internal source inductance	L _S	6 mm (0.25") from package and center of die contact c		-	7.5	-	nH
Drain-Source Body Diode Characteristic	s						•
Continuous source-drain diode current	I _S	MOSFET sym	bol	-	-	-5.1	
Pulsed diode forward current ^a	I _{SM}	showing the integral reverse p - n junction diode		-	-	-20	А
Body diode voltage	V _{SD}	T _J = 25 °C, I _S	= -5.1 A, V _{GS} = 0 V ^b	-	-	-5.5	V
Body diode reverse recovery time	t _{rr}			-	80	160	ns
Body diode reverse recovery charge	Q _{rr}	$T_J = 25 ^{\circ}\text{C}, I_F$	= -6.7 A, $dI/dt = 100 A/\mu s^b$	-	0.096	0.19	μC
Forward turn-on time	t _{on}	Intrinsic turn-on time is negligible (turn-		on is dor	ninated h	v I - and	1 \

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b. Pulse width \leq 300 µs; duty cycle \leq 2 %

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

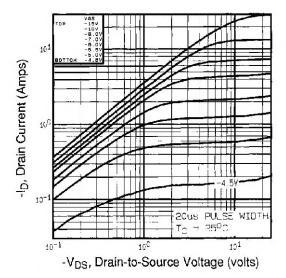


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

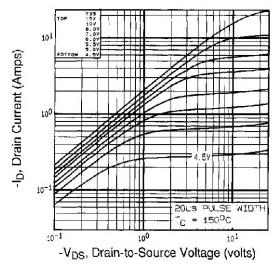


Fig. 2 - Typical Output Characteristics, T_C = 150 °C

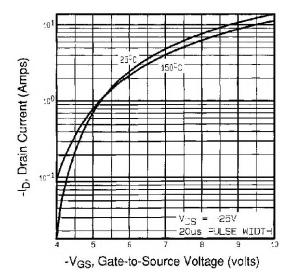


Fig. 3 - Typical Transfer Characteristics

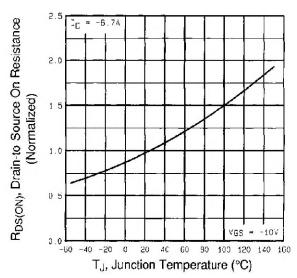


Fig. 4 - Normalized On-Resistance vs. Temperature

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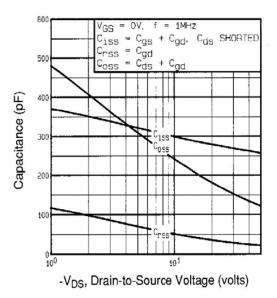


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

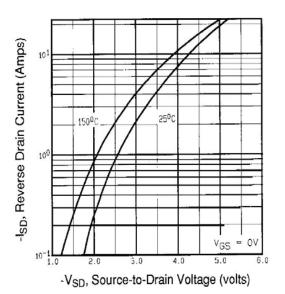


Fig. 7 - Typical Source-Drain Diode Forward Voltage

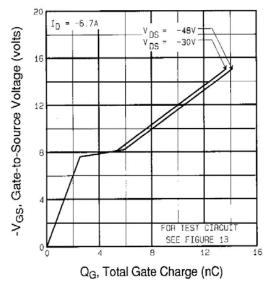


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

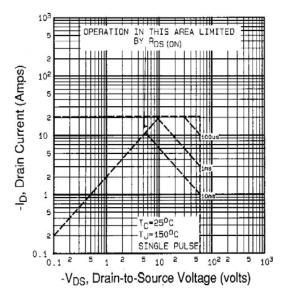


Fig. 8 - Maximum Safe Operating Area

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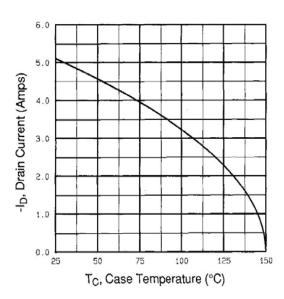


Fig. 9 - Maximum Drain Current vs. Case Temperature

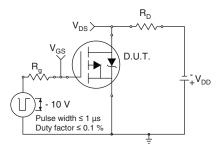


Fig. 10a - Switching Time Test Circuit

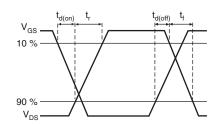


Fig. 10b - Switching Time Waveforms

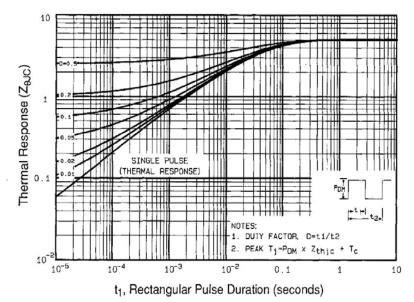


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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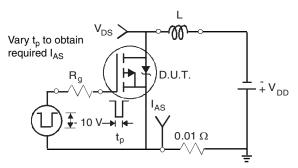


Fig. 12a - Unclamped Inductive Test Circuit

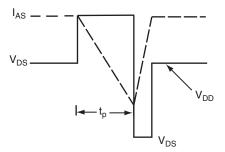


Fig. 12b - Unclamped Inductive Waveforms

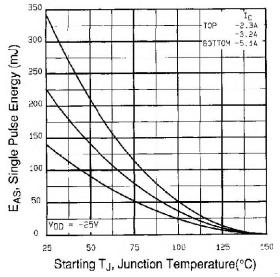


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

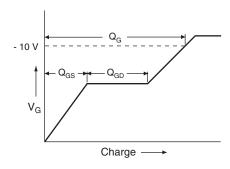


Fig. 13a - Basic Gate Charge Waveform

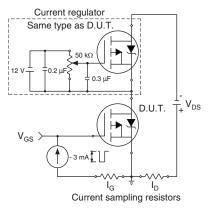
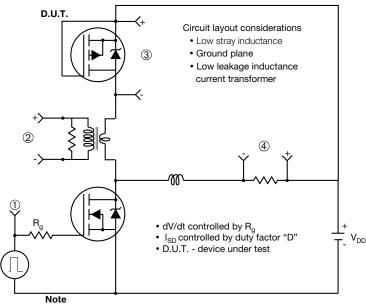


Fig. 13b - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit



• Compliment N-Channel of D.U.T. for driver

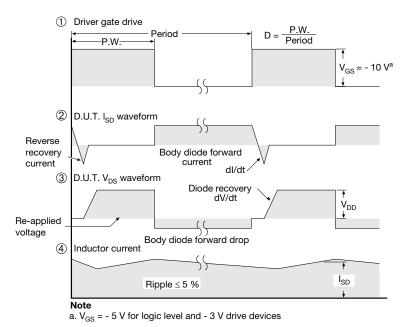


Fig. 14 - For P-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?91277.

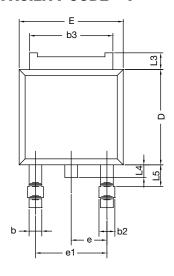
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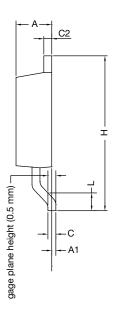


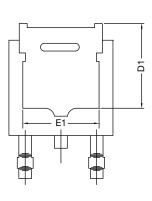
TO-252AA Case Outline

VERSION 1: FACILITY CODE = Y

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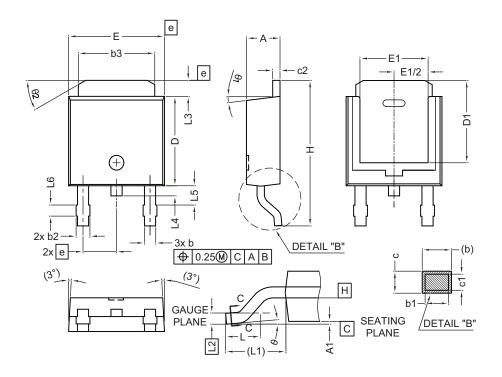
	MILLIN	METERS
DIM.	MIN.	MAX.
Α	2.18	2.38
A1	-	0.127
b	0.64	0.88
b2	0.76	1.14
b3	4.95	5.46
С	0.46	0.61
C2	0.46	0.89
D	5.97	6.22
D1	4.10	-
E	6.35	6.73
E1	4.32	-
Н	9.40	10.41
е	2.28	BSC
e1	4.56	BSC
L	1.40	1.78
L3	0.89	1.27
L4	-	1.02
L5	1.01	1.52

Note

• Dimension L3 is for reference only



VERSION 2: FACILITY CODE = N



	MILLIMETERS		
DIM.	MIN.	MAX.	
Α	2.18	2.39	
A1	-	0.13	
b	0.65	0.89	
b1	0.64	0.79	
b2	0.76	1.13	
b3	4.95	5.46	
С	0.46	0.61	
c1	0.41	0.56	
c2	0.46	0.60	
D	5.97	6.22	
D1	5.21	=	
Е	6.35	6.73	
E1	4.32	=	
е	2.29 BSC		
Н	9.94	10.34	

	MILLIMETERS		
DIM.	MIN.	MAX.	
L	1.50	1.78	
L1	2.74	ref.	
L2	0.51 BSC		
L3	0.89	1.27	
L4	-	1.02	
L5	1.14	1.49	
L6	0.65	0.85	
θ	0°	10°	
θ1	0°	15°	
θ2	25°	35°	

Notes

- Dimensioning and tolerance confirm to ASME Y14.5M-1994
- All dimensions are in millimeters. Angles are in degrees
- Heat sink side flash is max. 0.8 mm
- · Radius on terminal is optional

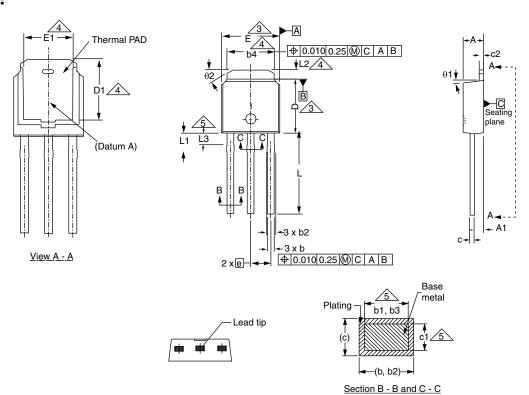
ECN: E19-0649-Rev. Q, 16-Dec-2019

DWG: 5347

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Case Outline for TO-251AA (High Voltage)

OPTION 1:



	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
Α	2.18	2.39	0.086	0.094
A1	0.89	1.14	0.035	0.045
b	0.64	0.89	0.025	0.035
b1	0.65	0.79	0.026	0.031
b2	0.76	1.14	0.030	0.045
b3	0.76	1.04	0.030	0.041
b4	4.95	5.46	0.195	0.215
С	0.46	0.61	0.018	0.024
c1	0.41	0.56	0.016	0.022
c2	0.46	0.86	0.018	0.034
D	5.97	6.22	0.235	0.245

	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
D1	5.21	-	0.205	-
Е	6.35	6.73	0.250	0.265
E1	4.32	=	0.170	=
е	2.29	2.29 BSC		BSC
L	8.89	9.65	0.350	0.380
L1	1.91	2.29	0.075	0.090
L2	0.89	1.27	0.035	0.050
L3	1.14	1.52	0.045	0.060
θ1	0'	15'	0'	15'
θ2	25'	35'	25'	35'
	•		•	

ECN: E21-0682-Rev. C, 27-Dec-2021

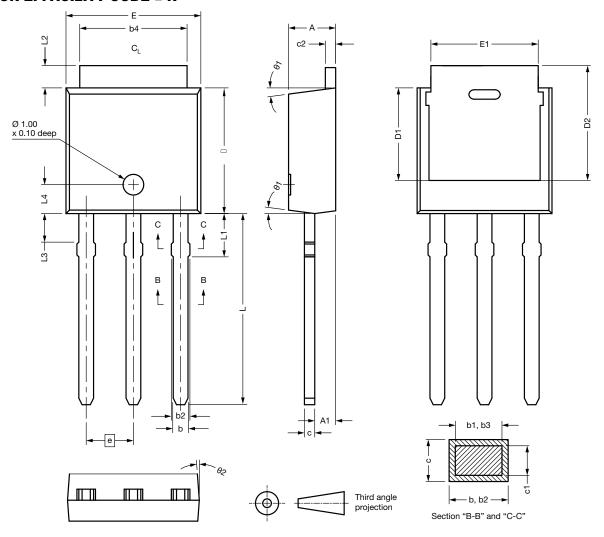
DWG: 5968

Notes

- Dimensioning and tolerancing per ASME Y14.5M-1994
- Dimension are shown in inches and millimeters
- Dimension D and E do not include mold flash. Mold flash shall not exceed 0.13 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- Thermal pad contour optional with dimensions b4, L2, E1 and D1
- Lead dimension uncontrolled in L3
- Dimension b1, b3 and c1 apply to base metal only
- Outline conforms to JEDEC® outline TO-251AA



OPTION 2: FACILITY CODE = N



DIM.	MIN.	NOM.	MAX.
Α	2.180	2.285	2.390
A1	0.890	1.015	1.140
b	0.640	0.765	0.890
b1	0.640	0.715	0.790
b2	0.760	0.950	1.140
b3	0.760	0.900	1.040
b4	4.950	5.205	5.460
С	0.460	-	0.610
c1	0.410	-	0.560
c2	0.460	-	0.610
D	5.970	6.095	6.220
D1	4.300	-	-

DIM.	MIN.	NOM.	MAX.
D2	5.380	-	-
E	6.350	6.540	6.730
E1	4.32	-	-
е	2.29	BSC	
L	8.890	9.270	9.650
L1	1.910	2.100	2.290
L2	0.890	1.080	1.270
L3	1.140	1.330	1.520
L4	1.300	1.400	1.500
θ1	0°	7.5°	15°
θ2	4°	-	-

ECN: E21-0682-Rev. C, 27-Dec-2021

DWG: 5968

- Dimensioning and tolerancing per ASME Y14.5M-1994
- All dimension are in millimeters, angles are in degrees
- Heat sink side flash is max. 0.8 mm



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



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